JC12 Rec'd PCT/PTC 1 8 APR 2005

Application Data Sheet

Application Information

Title::

Application Type:: Regular

Subject Matter:: Utility

Suggested Group Art Unit:: N/A

CD-ROM or CD-R?:: None

Sequence submission?:: None

Computer Readable Form (CRF)?:: No

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METHOD FOR FORMING COMPACT

FROM POWDER AND MOLD APPARATUS

FOR POWDER MOLDING (AS AMENDED)

Attorney Docket Number:: 09864/0202607-US0

Request for Early Publication?:: No

Request for Non-Publication?:: No

Suggested Drawing Figure:: Fig. 1

Total Drawing Sheets:: 3

Small Entity?:: No

Petition included?:: No

Secrecy Order in Parent Appl.?:: No

Applicant Information

Applicant Authority Type:: Inventor

Primary Citizenship Country:: Japan

Status:: Full Capacity

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Applicant Authority Type::

Inventor

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Correspondence Information

Correspondence Customer Number:

07278

Representative Information

Representative Customer Number::

07278

Domestic Priority Information

Application::	Continuity Type::	Parent Application::	Parent Filing Date::
This Application	National Stage of	PCT/JP2003/014643	11/18/03

Foreign Priority Information



Country::	Application number::	Filing Date::	Priority Claimed::
Japan	2002-338621	11/21/02	No

Assignee Information

Assignee name::

Mitsubishi Materials Corporation

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